



Applicant: SALMAN AKRAM  
Title: METHOD OF FABRICATING MOUNTED MULTIPLE SEMICONDUCTOR DIES IN A PACKAGE  
Docket No.: MCT.0012D1US  
Serial No.: 09/853,111  
Atty: Timothy N. Trop, Reg. No. 28,994, (713) 468-8880  
Sheet 1 of 3

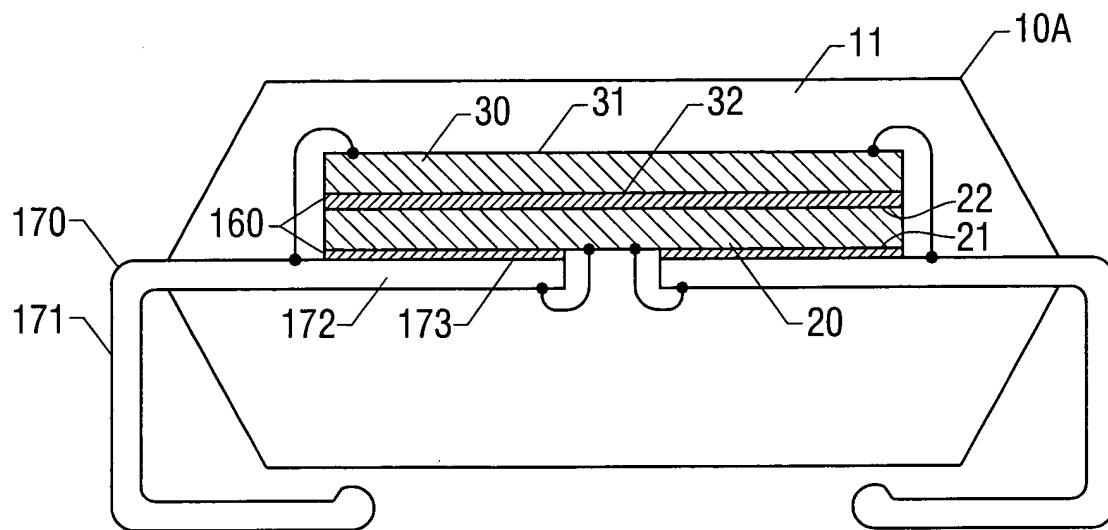


FIG. 1

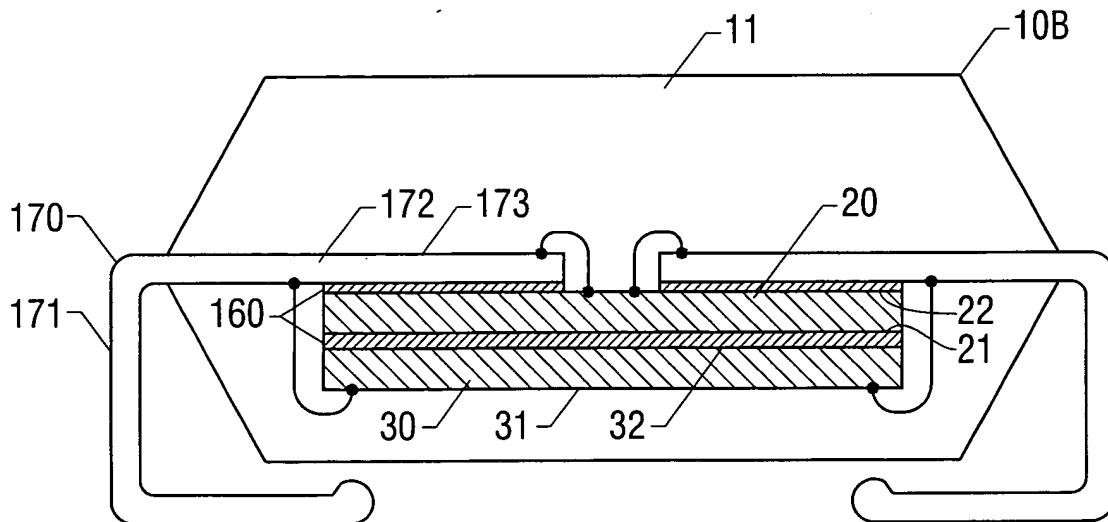


FIG. 2

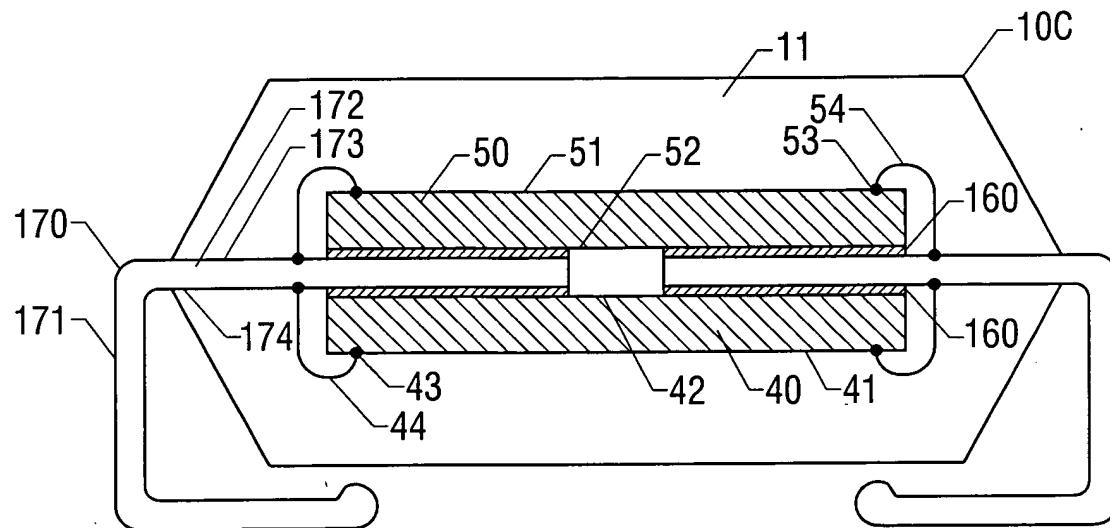


FIG. 3

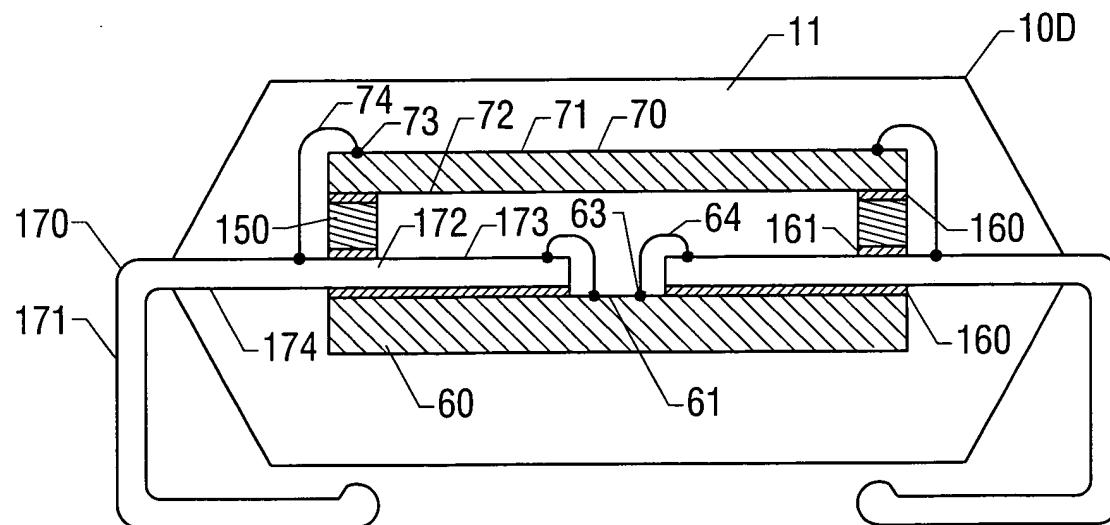


FIG. 4

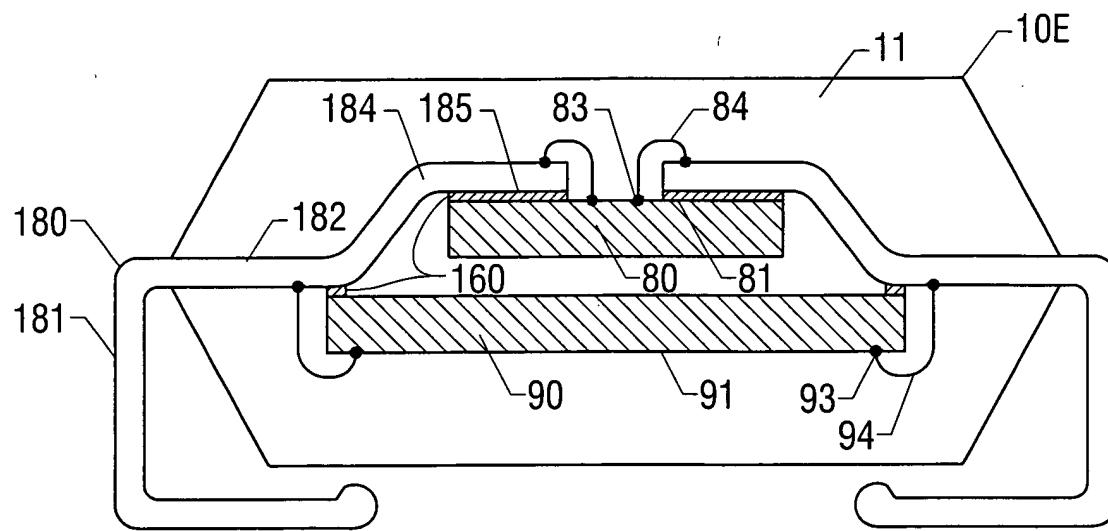


FIG. 5

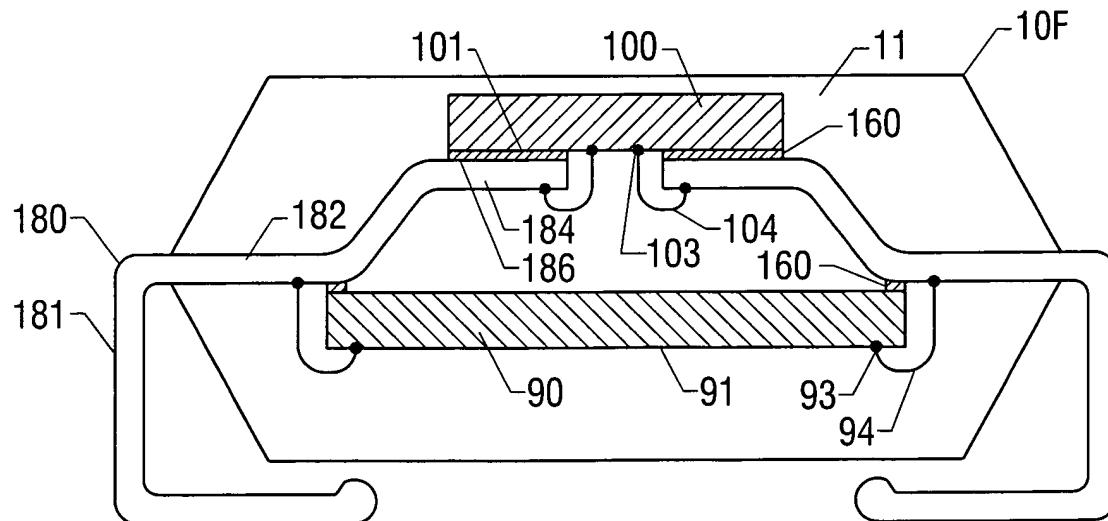


FIG. 6